

#### **Features**

- Trench Power MV MOSFET Technology
- Excellent Package for Heat Dissipation
- High Density Cell Design for Low R<sub>DS(ON)</sub>
- Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

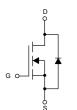
# **Maximum Ratings**

- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 73.5°C/W Junction to Ambient (2)

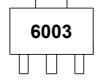
Parameter	Symbol	Rating	Unit	
Drain-Source Voltage		V <sub>DS</sub>	60	V
Gate-Source Volltage		V <sub>GS</sub>	±20	V
Continuous Drain Current	T <sub>A</sub> =25°C	- I <sub>D</sub>	3	Α
	T <sub>A</sub> =70°C	'D	2.4	Α
Pulsed Drain Current (3)		I <sub>DM</sub>	12	Α
Total Power Dissipation		P <sub>D</sub>	1.7	W

- Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - 2. Device Mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch.
  - 3.Pulse Test: Pulse Width≤300µs,Duty Cycle ≤2%.

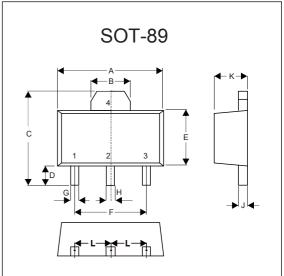
## **Internal Structure and Marking Code**



- 1. Gate
- 2,4. Drain
- 3. Source

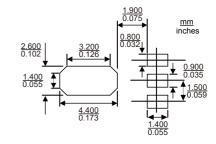


# N-CHANNEL MOSFET



DIMENSIONS						
DIM	INCHES		MM		NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOTE	
Α	0.169	0.185	4.30	4.70		
В	0.061		1.55		TYP.	
С	0.154	0.171	3.91	4.35		
D	0.031	0.047	0.80	1.20		
Е	0.089	0.104	2.25	2.65		
F	0.118		3.00		TYP.	
G	0.013	0.020	0.33	0.52		
Ι	0.015	0.021	0.38	0.53		
J	0.014	0.017	0.35	0.44		
K	0.055	0.063	1.40	1.60		
L	0.059		1.50		TYP.	

## Suggested Solder Pad Layout



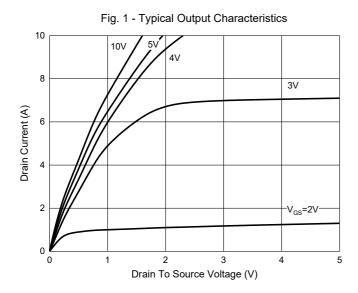


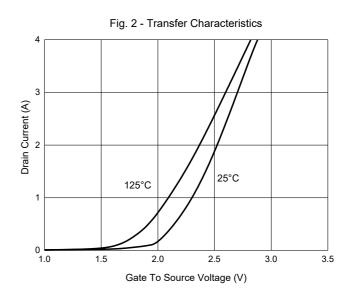
# Electrical Characteristics @ 25°C (Unless Otherwise Specified)

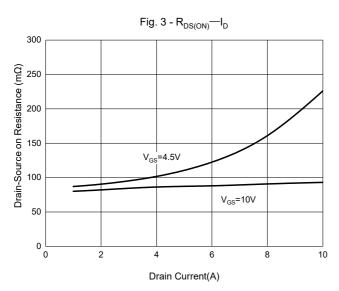
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static Characteristics				1		I
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60			V
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μA
Gate-Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	0.65	0.95	1.55	V
Drain-Source On-Resistance		V <sub>GS</sub> =10V, I <sub>D</sub> =3A		86	100	mΩ
	R <sub>DS(on)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =2A		90	120	mΩ
Diode Characteristics			'	•		
Continuous Body Diode Current	Is				3	Α
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =3A		0.8	1.2	V
Dynamic Characteristics						1
Input Capacitance	C <sub>iss</sub>			340		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V,f=1MHz		95		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			17		
Total Gate Charge	Qg			5.2		
Gate-Source Charge	$Q_{gs}$	$V_{DS}$ =30V, $V_{GS}$ =10V, $I_{D}$ =3A		1.3		nC
Gate-Drain Charge	$Q_{gd}$			1.7		
Turn-On Delay Time	t <sub>d(on)</sub>			13		
Turn-On Rise Time	t <sub>r</sub>	V <sub>GS</sub> =10V,V <sub>DD</sub> =30V, I <sub>D</sub> =1.5A,		51		ne
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_L=1\Omega$ , $R_{GEN}=3\Omega$		19		ns
Turn-Off Fall Time	t <sub>f</sub>			12		

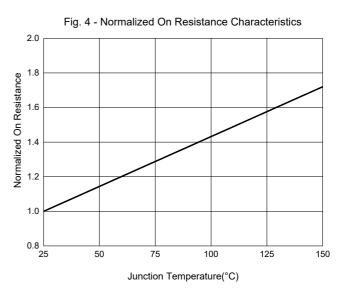


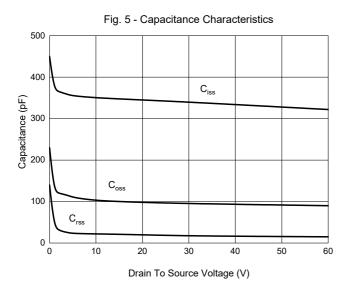
### **Curve Characteristics**

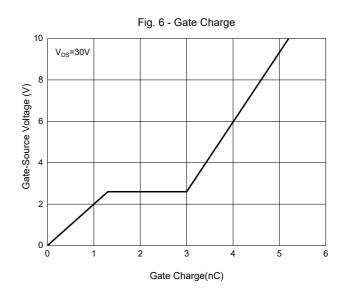






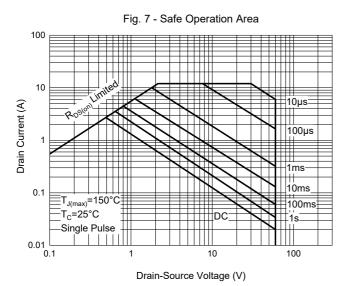








# **Curve Characteristics**





## **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 1Kpcs/Reel

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